

**Dual Power MOSFET Module** 

Preliminary

 $V_{DSS} = 70 V$ 

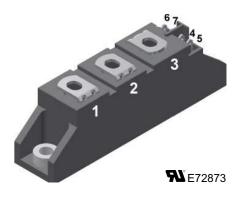
 $I_{D25} = 165 A$ 

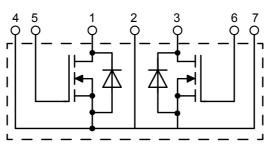
 $R_{DS(on)} = 7 \text{ m}\Omega$ 

Common-Source connected N-Channel Enhancement Mode

## Part number

VMK165-007T





### Features / Advantages:

- Two MOSFET with common source
- Direct copper bonded Al<sub>2</sub>O<sub>3</sub> ceramic base plate
- $\bullet \ \mathsf{Low} \ \mathsf{R}_{\mathsf{DS}(\mathsf{on})} \ \mathsf{HDMOS^{\mathsf{TM}}} \ \mathsf{process}$
- Low package inductance for high speed switching
- Kelvin source contact
- Keyed twin plugs
- · High power density
- Low losses

### **Applications:**

- Push-pull inverters
- Switched-mode and resonant-mode power supplies
- Uninterruptible power supplies (UPS)
- AC static switches

## Package: TO-240AA

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

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MOSFETs			Ratings				
Symbol	Definitions	Conditions	min.	typ.	max.	Unit	
$V_{\scriptscriptstyle DSS}$	drain source breakdown voltage	$T_{VJ} = 25^{\circ}C \text{ to} 125^{\circ}C$			70	V	
<b>V</b> <sub>DGR</sub>	drain gate voltage	$R_{GS} = 6.8 \text{ k}\Omega$ $T_{VJ} = 25^{\circ}\text{C to}125^{\circ}\text{C}$			70	V	
V <sub>GS</sub> V <sub>GSM</sub>	gate source voltage max. transient gate source voltage	Continuous Transient			±20 ±30	V V	
I <sub>D25</sub> I <sub>D100</sub> I <sub>DM</sub>	continuous drain current drain current maximum pulsed drain current	$$T_{\text{C}}$=$~25^{\circ}\text{C}$$ $$T_{\text{C}}$=$100^{\circ}\text{C}$$ $$t_{p}$=$10~\mu s$, pulse width limited by $T_{\text{JM}}$$ $$T_{\text{C}}$=$~25^{\circ}\text{C}$$			165 104 660	A A A	
P <sub>tot</sub>	total power dissipation	$T_{VJ} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$			390	W	
$V_{\scriptscriptstyle DSS}$	drain source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1 \text{ mA}$	70			V	
$V_{GS(th)}$	gate threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = 8 \text{ mA}$	2		4	V	
I <sub>GSS</sub>	gate source leakage current	$V_{GS} = \pm 20 \text{ V DC}; V_{DS} = 0$			500	nΑ	
I <sub>DSS</sub>	drain source leakage current	$V_{DS} = V_{DSS};$ $V_{GS} = 0 \text{ V}$ $T_{VJ} = 25^{\circ}\text{C}$ $V_{DS} = 0.8 \bullet V_{DSS};$ $V_{GS} = 0 \text{ V}$ $T_{VJ} = 125^{\circ}\text{C}$			200 1	μA mA	
R <sub>DS(on)</sub>	staticdrain source on resistance	$V_{GS}$ = 10 V; $I_D$ = 0.5 • $I_{D25}$ $T_{VJ}$ = 25°C Pulse test, t ≤ 300 µs, duty cycle d ≤ 2 %		6	7	mΩ	
<b>g</b> <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 0.5 • I <sub>D25</sub> pulsed	60	80		S	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	input capacitance output capacitance reverse transfer (Miller) capacitance			8.8 4.0 2.4		nF nF nF	
$\mathbf{t}_{d(on)} \\ \mathbf{t}_{r} \\ \mathbf{t}_{d(off)} \\ \mathbf{t}_{f}$	turn-on delay time current rise time turn-off delay time current fall time	$V_{GS} = 10 \text{ V; } V_{DS} = 0.5 \bullet V_{DSS}; I_D = 0.5 \bullet I_{D25}$ $R_G = 1 \Omega \text{ (external), resistive load}$		120 280 390 110		ns ns ns	
$egin{array}{c} egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}$	total gate charge gate source charge gate drain (Miller) charge			480 60 240		nC nC nC	
$R_{thJC}$ $R_{thJH}$	thermal resistance junction to case thermal resistance junction to heatsink	with heat transfer paste		0.2	0.32	K/W K/W	

Source-Drain Diodes						
Symbol	Definitions	Conditions	min.	typ.	max.	
Is	continuous source current	$V_{GS} = 0 \text{ V}$			165	Α
I <sub>SM</sub>	maximum pulsed source current	Repetitive; pulse width limited by T <sub>JM</sub>			660	Α
V <sub>SD</sub>	forward voltage drop	$I_F = I_S; V_{GS} = 0 \text{ V}$ Pulse test, $t \le 300 \mu\text{s}$ , duty cycle d $\le 2 \%$			1.5	V
t <sub>rr</sub>	reverse recovery time	$I_F = 50 \text{ A}, -di/dt = 200 \text{ A/}\mu\text{s}; V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}$		150		ns

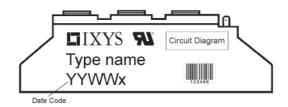
Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  $T_J = 25^{\circ}C$ , unless otherwise specified





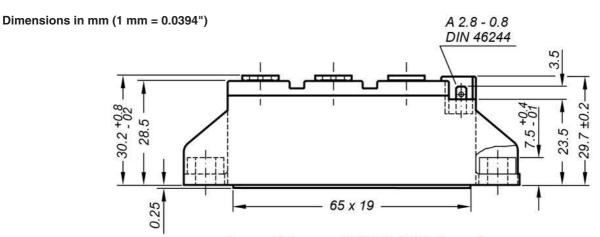
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Package	TO-240AA				Ratings			
Symbol	Definitions	Conditions			min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per terminal					200	Α
T <sub>VJ</sub>	virtual junction temperature				-40		150	°C
T <sub>VJM</sub>	maximum virtual junction temperature						150	°C
T <sub>stg</sub>	storage temperature				-40		125	°C
Weight						81		g
M <sub>D</sub>	mounting torque terminal torque				2.5 2.5		4 4	Nm Nm
d <sub>Spp/App</sub>	creepage distance on surface   striking dist	a Latriking diatanga through air	terminal to terminal	13.0	9.7			mm
$\mathbf{d}_{Spb/Apb}$		e i strikirig distance trirough ali	terminal to backside	16.0	16.0			mm
V <sub>ISOL</sub>	isolation voltage	t = 1 second	50/60 Hz, RMS, I <sub>ISOL</sub> ≤ 1 mA		4800			V
		t = 1 minute			4000			V

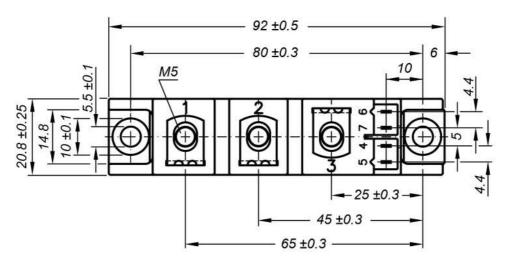


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# Outlines TO-240AA



General tolerance: DIN ISO 2768 class "c"



Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red Type ZY 200L (L = Left for pin pair 4/5) Type ZY 200R (R = Right for pin pair 6/7) UL 758, style 3751

